Rev. 1 — 14 January 2020

Objective data sheet

1. Product profile

1.1 General description

A 2000 W advanced ruggedness LDMOS power transistor for industrial, scientific and medical applications in the HF to 400 MHz band.

Table 1. Application information

Test signal	f	V _{DS}	PL	Gp	ηD
	(MHz)	(V)	(W)	(dB)	(%)
CW	41	65	1600	25	78
CW	60	65	1750	20	80
CW pulsed [1]	64	63	2100	27	78
CW [2]	87.5 to 108	60	1775	22.2	80.9
CW [2]	87.5 to 108	58	1695	22.0	81.7

^[1] $t_p = 10 \text{ ms}; \delta = 10 \%.$

1.2 Features and benefits

- High breakdown voltage enables class E operation up to V_{DS} = 50 V
- Qualified up to a maximum of V_{DS} = 65 V
- Characterized from 30 V to 65 V for extended power range
- Easy power control
- Integrated dual sided ESD protection enables class C operation and complete switch off of the transistor
- Excellent ruggedness with no device degradation
- High efficiency
- Excellent thermal stability
- Designed for broadband operation
- For RoHS compliance see the product details on the Ampleon website

1.3 Applications

- Industrial, scientific and medical applications
 - Plasma generators
 - MRI systems
 - ◆ CO₂ lasers
 - ◆ Particle accelerators
- Radio and VHF TV broadcast transmitters
- Aerospace
 - HF communications
 - Radar

^[2] Center band performance numbers across the indicated frequency range.

2. Pinning information

Table 2. Pinning

Description	Simplified outline	Graphic symbol
drain1		
drain2	1 2	1
gate1	5	
gate2	3 4	3——5
source	[1]	4 7
		'┡─┐
		2 sym117
	drain1 drain2 gate1 gate2	drain1 drain2 gate1 gate2

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Packag	ge general de la companya de la comp	
	Name	Description	Version
ART2K0FE	-	flanged balanced ceramic package; 2 mounting holes; 4 leads	SOT539A

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	200	V
V_{GS}	gate-source voltage		-6	+11	V
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[1]	-	225	°C

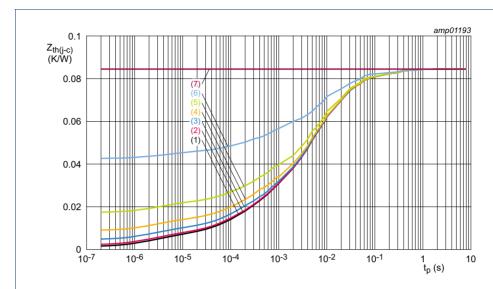
Continuous use at maximum temperature will affect the reliability, for details refer to the online MTF calculator.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions		Тур	Unit
R _{th(j-c)}	thermal resistance from junction to case	T _j = 150 °C	[1][2]	0.085	K/W
Z _{th(j-c)}	transient thermal impedance from junction to case	T_j = 150 °C; t_p = 100 μs; $δ$ = 10 %	[3]	0.02	K/W

- [1] T_j is the junction temperature.
- [2] R_{th(j-c)} is measured under RF conditions.
- [3] See Figure 1.



- (1) $\delta = 1 \%$
- (2) $\delta = 2 \%$
- (3) $\delta = 5 \%$
- (4) $\delta = 10 \%$
- (5) $\delta = 20 \%$
- (6) $\delta = 50 \%$
- (7) $\delta = 100 \% (DC)$

Fig 1. Transient thermal impedance from junction to case as a function of pulse duration

6. Characteristics

Table 6. DC characteristics

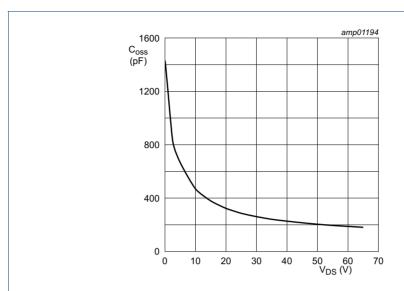
 T_i = 25 °C; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 5.5 \text{ mA}$	200	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$V_{DS} = 20 \text{ V}; I_D = 550 \text{ mA}$	1.5	2.1	2.5	V
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 65 V	-	-	2.8	μА
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 20 \text{ V}$	-	77	-	A
I _{GSS}	gate leakage current	V _{GS} = 11 V; V _{DS} = 0 V	-	-	280	nA
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 19.25 \text{ A}$	_	0.100	-	Ω

Table 7. AC characteristics

 T_i = 25 °C; per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _{rs}	feedback capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 65 \text{ V}; f = 1 \text{ MHz}$	-	1.73	-	pF
C _{iss}	input capacitance	V _{GS} = 0 V; V _{DS} = 65 V; f = 1 MHz	-	610	-	pF
Coss	output capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 65 \text{ V}; f = 1 \text{ MHz}$	-	181	-	pF



 $V_{GS} = 0 V; f = 1 MHz$

Fig 2. Output capacitance as a function of drain-source voltage; typical values per section

Table 8. RF characteristics

Test signal: pulsed RF; t_p = 100 μ s; δ = 5 %; f = 108 MHz; RF performance at V_{DS} = 65 V; I_{Dq} = 50 mA per section; T_{case} = 25 $^{\circ}$ C; unless otherwise specified; in a class-AB production test circuit.

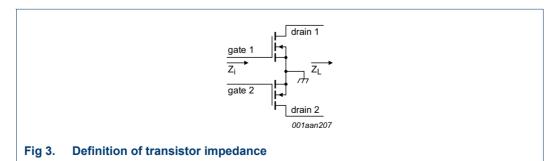
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	P _L = 2000 W	<tbd></tbd>	28.9	-	dB
RLin	input return loss	P _L = 2000 W	-	14.2	-	dB
η_{D}	drain efficiency	P _L = 2000 W	<tbd></tbd>	72.9	-	%

7. Test information

7.1 Ruggedness in class-AB operation

The ART2K0FE is capable of withstanding a load mismatch corresponding to VSWR = 65 : 1 through all phases under the following conditions: V_{DS} = 65 V; I_{Dq} = 100 mA per section; P_L = 2000 W pulsed; f = 108 MHz.

7.2 Impedance information



ART2K0FE

Table 9. Typical push-pull impedance

Simulated Z_i and Z_L device impedance; impedance info at V_{DS} = 65 V and P_L = 2000 W.

f	Z _i	Z_L
(MHz)	(Ω)	(Ω)
108	2.4 – j8.7	3.8 + j1.0

7.3 Test circuit

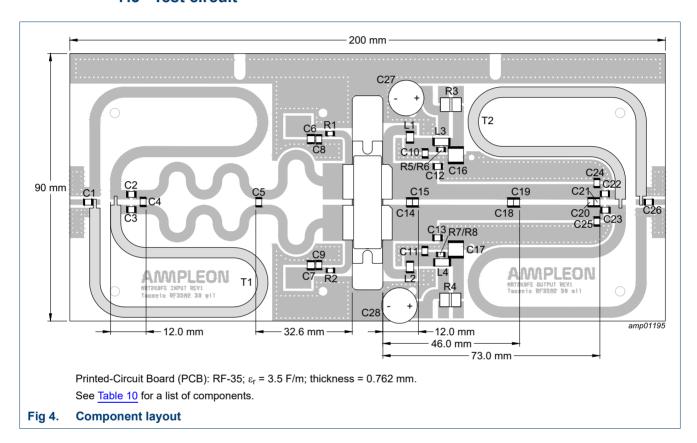


Table 10. List of components

For test circuit see Figure 4.

Component	Description	Value		Remarks
C1, C26	multilayer ceramic chip capacitor	470 pF	[1]	
C2, C3	multilayer ceramic chip capacitor	68 pF	[1]	
C4	multilayer ceramic chip capacitor	43 pF	[1]	
C5	multilayer ceramic chip capacitor	240 pF	[1]	
C6, C7	multilayer ceramic chip capacitor	4.7 μF, 50 V		Murata: GRM32ER71H475KA88L
C8, C9, C10, C11	multilayer ceramic chip capacitor	820 pF	[1]	
C12, C13	multilayer ceramic chip capacitor	180 pF	[1]	
C14, C15	multilayer ceramic chip capacitor	39 pF	[1]	
C16, C17	multilayer ceramic chip capacitor	4.7 μF, 100 V		TDK: C5750X7R2A475KT/A
C18, C19	multilayer ceramic chip capacitor	56 pF	[1]	
C20, C21	multilayer ceramic chip capacitor	51 pF	[1]	

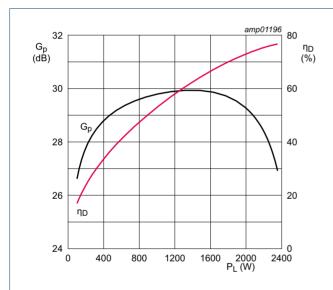
Table 10. List of components ...continued

For test circuit see Figure 4.

Component	Description	Value	Remarks
C22, C23	multilayer ceramic chip capacitor	120 pF [1]	
C24, C25	multilayer ceramic chip capacitor	20 pF [1]	
C27, C28	electrolytic capacitor	2200 μF, 100 V	
L1, L2	air inductor	47 nH	Coilcraft: 1515SQ-47N
L3, L4	air inductor	82 nH	Coilcraft: 1515SQ-82N
R1, R2	resistor	4.7 kΩ	SMD 1206
R3, R4	resistor	0.01 Ω	Vishay: WSHP2818
R5, R6, R7, R8	resistor	9.1 Ω	SMD 1206
T1, T2	semi rigid coax	50 Ω, 160 mm	EZ141-AL-TP/M17

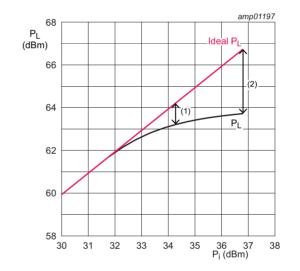
^[1] American Technical Ceramics type 100B or capacitor of same quality.

7.4 Graphical data



 V_{DS} = 65 V; I_{Dq} = 100 mA per section; f = 108 MHz; t_p = 100 μ s; δ = 10 %.

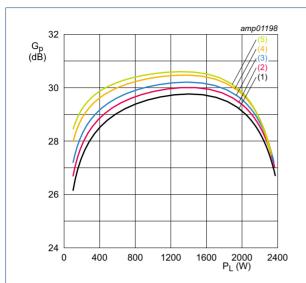
Fig 5. Power gain and drain efficiency as function of output power; typical values



 V_{DS} = 65 V; I_{Dq} = 100 mA per section; f = 108 MHz; t_p = 100 $\mu s; \, \delta$ = 10 %

- (1) $P_{L(1dB)} = 63.20 \text{ dBm } (2090 \text{ W})$
- (2) $P_{L(3dB)} = 63.71 \text{ dBm } (2350 \text{ W})$

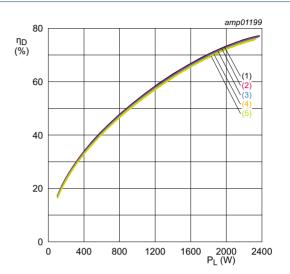
Fig 6. Output power as a function of input power; typical values



 V_{DS} = 65 V; f = 108 MHz; t_p = 100 μ s; δ = 10 %.

- (1) $I_{Dq} = 50 \text{ mA per section}$
- (2) $I_{Dq} = 100 \text{ mA per section}$
- (3) $I_{Dq} = 200 \text{ mA per section}$
- (4) $I_{Dq} = 400 \text{ mA per section}$
- (5) $I_{Dq} = 600 \text{ mA per section}$

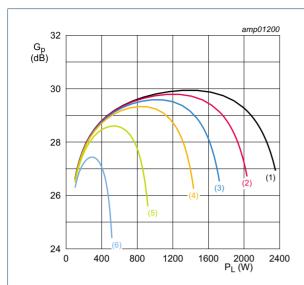
Fig 7. Power gain as a function of output power; typical values



 V_{DS} = 65 V; f = 108 MHz; t_p = 100 $\mu s;$ δ = 10 %.

- (1) $I_{Dq} = 50 \text{ mA per section}$
- (2) $I_{Dq} = 100 \text{ mA per section}$
- (3) I_{Dq} = 200 mA per section
- (4) $I_{Dq} = 400 \text{ mA per section}$
- (5) $I_{Dq} = 600 \text{ mA per section}$

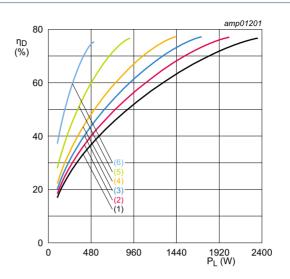
Fig 8. Drain efficiency as a function of output power; typical values



 I_{Dq} = 100 mA per section; f = 108 MHz; t_p = 100 $\mu s;$ δ = 10 %.

- (1) $V_{DS} = 65 \text{ V}$
- (2) $V_{DS} = 60 \text{ V}$
- (3) $V_{DS} = 55 V$
- (4) $V_{DS} = 50 \text{ V}$
- (5) $V_{DS} = 40 \text{ V}$
- (6) $V_{DS} = 30 \text{ V}$

Fig 9. Power gain as a function of output power; typical values



 I_{Dq} = 100 mA per section; f = 108 MHz; t_p = 100 $\mu s;$ δ = 10 %.

- (1) $V_{DS} = 65 \text{ V}$
- (2) $V_{DS} = 60 \text{ V}$
- (3) $V_{DS} = 55 V$
- (4) $V_{DS} = 50 \text{ V}$
- (5) $V_{DS} = 40 \text{ V}$
- (6) $V_{DS} = 30 \text{ V}$

Fig 10. Drain efficiency as a function of output power; typical values

8. Package outline

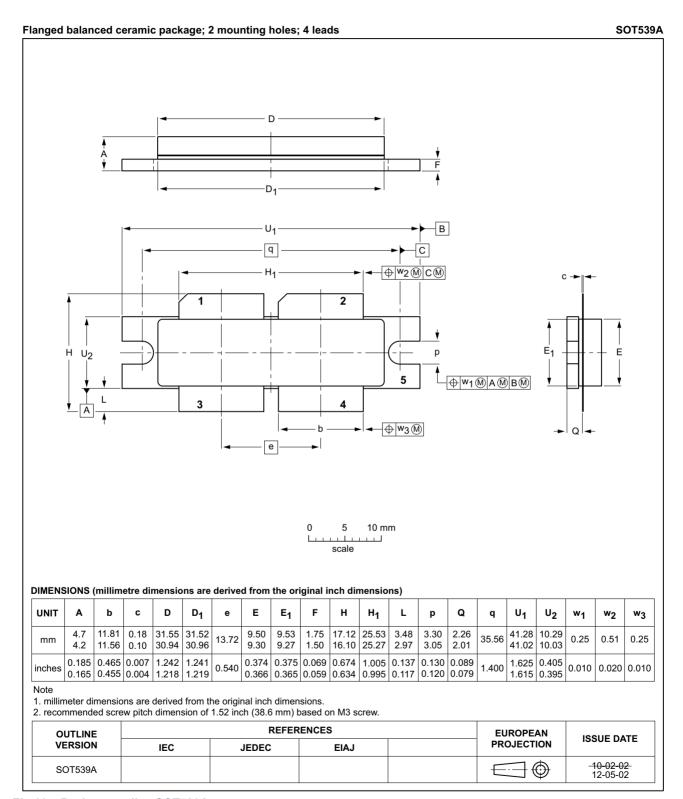


Fig 11. Package outline SOT539A

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

Table 11. ESD sensitivity

ESD model	Class
Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	<tbd>[1]</tbd>
Human Body Model (HBM); According to ANSI/ESDA/JEDEC standard JS-001	<tbd>[2]</tbd>

- [1] CDM classification <tbd> is granted to any part that passes after exposure to an ESD pulse of <tbd> V.
- [2] HBM classification <tbd> is granted to any part that passes after exposure to an ESD pulse of <tbd> V.

10. Abbreviations

Table 12. Abbreviations

Acronym	Description
CW	Continuous Wave
ESD	ElectroStatic Discharge
HF	High Frequency
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
MRI	Magnetic Resonance Imaging
MTF	Median Time to Failure
RoHS	Restriction of Hazardous Substances
SMD	Surface Mounted Device
VHF	Very High Frequency
VSWR	Voltage Standing Wave Ratio

11. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
ART2K0FE v.1	20200114	Objective data sheet	-	-

12. Legal information

12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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